Surface Mount Schottky Power Rectifier

SMA Power Surface Mount Package

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.

- Ultra Low V_F
- 1st in the Market Place with a 10 VR Schottky Rectifier
- Compact Package with J–Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Optimized for Low Forward Voltage

Mechanical Characteristics:

- Case: Molded Epoxy
- Epoxy Meets UL94, VO at 1/8"
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Ratings: Machine Model = C
 - Human Body Model = 3A
- Available in 12 mm Tape, 5000 Units per 13 inch Reel
- Marking: B2L1

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	10	V
Average Rectified Forward Current (At Rated V _R , T _L = 110°C)	IO	2.0	A
Non–Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	IFSM	230	A
Storage/Operating Case Temperature Operating Junction Temperature	T _{stg} , TC TJ	–55 to +125	°C
Voltage Rate of Change (Rated V _R , T _J = 25°C)	dv/dt	10,000	V/µs



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SCHOTTKY BARRIER RECTIFIER 2 AMPERES 10 VOLTS



B2L1

MARKING

B2L1 = Device Code

ORDERING INFORMATION

Device	Package Shipping	
MBRA210LT3	SMA	5000/Tape & Reel

THERMAL CHARACTERISTICS

Characteristic	Symbol	Min Pad	1 Inch Pad	Unit
Thermal Resistance – Junction–to–Lead	R _{θJL}	22	15	°C/W
Thermal Resistance – Junction–to–Ambient	R _{θJA}	150	81	

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 1)	VF	T _J = 25°C	T _J = 100°C	V
$(I_F = 0.1 A)$ $(I_F = 1.0 A)$ $(I_F = 2.0 A)$		0.260 0.325 0.350	0.15 0.23 0.26	
Maximum Instantaneous Reverse Current	I _R	Tj = 25°C	T _J = 100°C	mA
(V _R = 5.0 V) (V _R = 10 V)		0.25 0.70	40 60	

1. Pulse Test: Pulse Width \leq 250 µs, Duty Cycle \leq 2%.

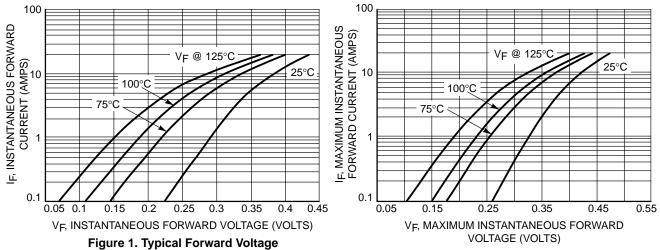
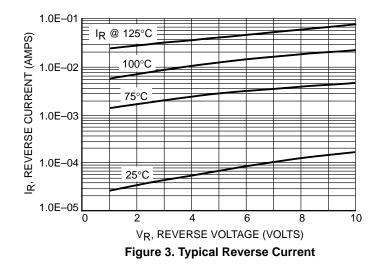


Figure 2. Maximum Forward Voltage



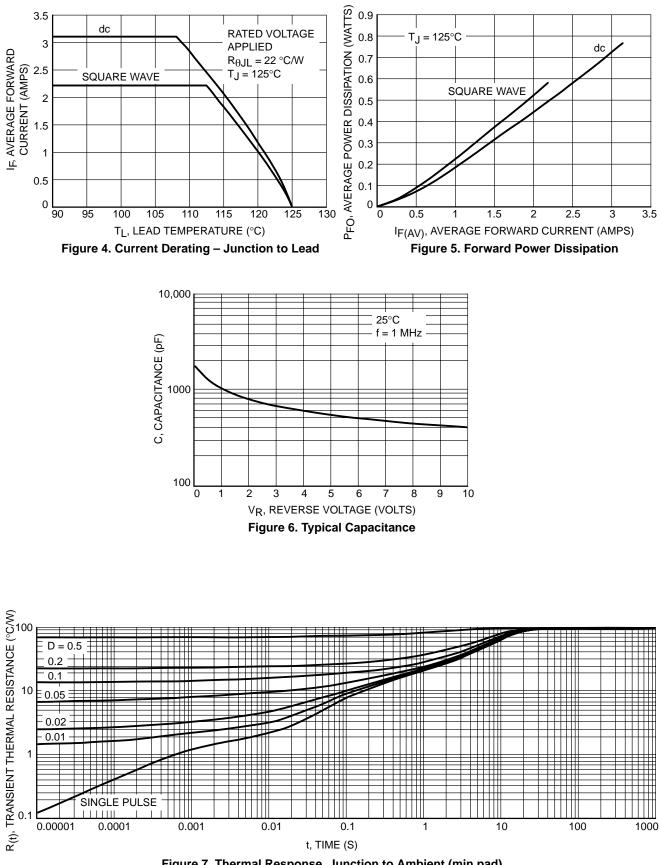


Figure 7. Thermal Response, Junction to Ambient (min pad)

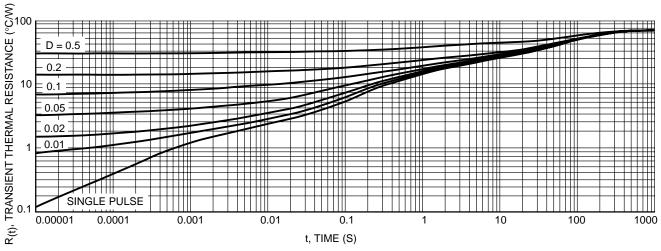
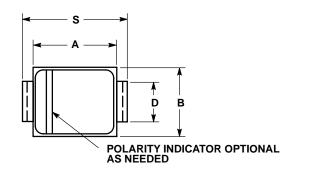


Figure 8. Thermal Response, Junction to Ambient (1 inch pad)

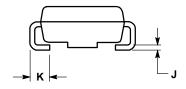
PACKAGE DIMENSIONS

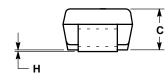
SMA CASE 403D-02 ISSUE A

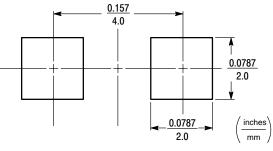


NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. 403D-01 OBSOLETE, NEW STANDARD IS 403D-02.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.160	0.180	4.06	4.57
В	0.090	0.115	2.29	2.92
С	0.075	0.095	1.91	2.41
D	0.050	0.064	1.27	1.63
Н	0.002	0.006	0.05	0.15
ſ	0.006	0.016	0.15	0.41
Κ	0.030	0.060	0.76	1.52
S	0.190	0.220	4.83	5.59







SMA FOOTPRINT

<u>Notes</u>

<u>Notes</u>

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